



#10 IDS
M. Brunson
8/15/02
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Jeun et al.
Ser. No. : 09/677,558
Filed : September 29, 2000
For : Semiconductor Power Module
Having an Electrically Insulating
Heat Sink and Method of
Manufacturing the Same
Art Unit : 2814
Examiner : DiLinh Nguyen

I hereby certify that this paper is being
deposited with the United States Postal
Service as First Class Mail, postage
prepaid, in an envelope addressed to:
Commissioner for Patents
Washington, D.C. 20231, on this date:
Date: August 5, 2002

James P. Zeller
Registration No. 28,491

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

Pursuant to the duty of disclosure under 37 C.F.R. §1.56, the documents identified on the enclosed form PTO-1449, copies of which are enclosed, are submitted herewith for consideration in connection with the present application.

The enclosed documents were first cited by a foreign patent office in a related foreign application less than three months from the filing date of this paper. Accordingly, no fee is due.

Respectfully submitted,

MARSHALL, GERSTEIN & BORUN

By:


James P. Zeller
Registration No. 28,491
6300 Sears Tower
233 South Wacker Drive
Chicago, Illinois 60606-6357
(312) 474-6300

Date: August 5, 2002

08/21/2002 ANISE1 00000021 132855 09677558
01 FC:126 100.00 CH